## NPN Silicon RF Transistor

- For broadband amplifiers up to 1 GHz at collector currents from 1 mA to 20 mA
- BFS17S: For orientation in reel see package information below
- Pb-free (RoHS compliant) package


ESD (Electrostatic discharge) sensitive device, observe handling precaution!

| Type | Marking | Pin Configuration |  |  |  |  | Package |  |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| BFS17S | MCs | $1=\mathrm{B} 1$ | $2=\mathrm{E} 1$ | $3=\mathrm{C} 2$ | $4=\mathrm{B} 2$ | $5=\mathrm{E} 2$ | $6=\mathrm{C} 1$ | SOT363 |

Maximum Ratings at $T_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise specified

| Parameter | Symbol | Value | Unit |
| :---: | :---: | :---: | :---: |
| Collector-emitter voltage | $V_{\text {CEO }}$ | 15 | V |
| Collector-base voltage | $V_{\text {CBO }}$ | 25 |  |
| Emitter-base voltage | $V_{\text {EBO }}$ | 2.5 |  |
| Collector current | $I_{C}$ | 25 | mA |
| Peak collector current, $f=10 \mathrm{MHz}$ | $I_{\text {CM }}$ | 50 |  |
| Total power dissipation ${ }^{1)}$ $T_{\mathrm{S}} \leq 93^{\circ} \mathrm{C}$ | $P_{\text {tot }}$ | 280 | mW |
| Junction temperature | $T_{J}$ | 150 | ${ }^{\circ} \mathrm{C}$ |
| Ambient temperature | $T_{\text {A }}$ | -65 ... 150 |  |
| Storage temperature | $T_{\text {Sta }}$ | -65 ... 150 |  |

## Thermal Resistance

| Parameter | Symbol | Value | Unit |
| :--- | :--- | :--- | :--- |
| Junction - soldering point ${ }^{2}$ ) | $R_{\text {thJS }}$ | $\leq 240$ | K/W |

[^0]Electrical Characteristics at $T_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise specified

| Parameter | Symbol | Values |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | min. | typ. | max. |  |
| DC Characteristics |  |  |  |  |  |
| Collector-emitter breakdown voltage $I_{C}=1 \mathrm{~mA}, I_{B}=0$ | $V_{(B R) C E O}$ | 15 | - | - | V |
| Collector-base cutoff current $\begin{aligned} & V_{\mathrm{CB}}=10 \mathrm{~V}, I_{\mathrm{E}}=0 \\ & V_{\mathrm{CB}}=25 \mathrm{~V}, I_{\mathrm{E}}=0 \end{aligned}$ | $I_{\text {CBO }}$ | - | - | $\begin{gathered} 0.05 \\ 10 \end{gathered}$ | $\mu \mathrm{A}$ |
| Emitter-base cutoff current $V_{\mathrm{EB}}=2.5 \mathrm{~V}, I_{\mathrm{C}}=0$ | IEBO | - | - | 100 |  |
| DC current gain <br> $I_{\mathrm{C}}=2 \mathrm{~mA}, V_{\mathrm{CE}}=1 \mathrm{~V}$, pulse measured <br> $I_{C}=25 \mathrm{~mA}, V_{\mathrm{CE}}=1 \mathrm{~V}$, pulse measured | $h_{\text {FE }}$ | $\begin{aligned} & 40 \\ & 20 \end{aligned}$ | $70$ | $150$ | - |
| Collector-emitter saturation voltage $I_{\mathrm{C}}=10 \mathrm{~mA}, I_{\mathrm{B}}=1 \mathrm{~mA}$ | $V_{\text {CEsat }}$ | - | 0.1 | 0.4 | V |

BFS17S

Electrical Characteristics at $T_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise specified

| Parameter | Symbol | Values |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | min. | typ. | max. |  |
| AC Characteristics (verified by random sampling) |  |  |  |  |  |
| Transition frequency $\begin{aligned} & I_{\mathrm{C}}=2 \mathrm{~mA}, V_{\mathrm{CE}}=5 \mathrm{~V}, f=200 \mathrm{MHz} \\ & I_{\mathrm{C}}=25 \mathrm{~mA}, V_{\mathrm{CE}}=5 \mathrm{~V}, f=200 \mathrm{MHz} \end{aligned}$ | $f_{\top}$ | $\begin{gathered} 1 \\ 1.3 \end{gathered}$ | $\begin{aligned} & 1.4 \\ & 2.5 \end{aligned}$ |  | GHz |
| Collector-base capacitance $V_{\mathrm{CB}}=5 \mathrm{~V}, f=1 \mathrm{MHz}, V_{\mathrm{BE}}=0$ <br> emitter grounded | $C_{c b}$ | - | 0.55 | 0.8 | pF |
| Collector emitter capacitance $V_{\mathrm{CE}}=5 \mathrm{~V}, f=1 \mathrm{MHz}, V_{\mathrm{BE}}=0,$ <br> base grounded | $C_{\text {ce }}$ | - | 0.2 | - |  |
| Emitter-base capacitance $V_{\mathrm{EB}}=0.5 \mathrm{~V}, f=1 \mathrm{MHz}, V_{\mathrm{CB}}=0$ <br> collector grounded | $C_{\text {eb }}$ | - | 0.9 | 1.45 |  |
| Minimum noise figure $\begin{aligned} & I_{\mathrm{C}}=2 \mathrm{~mA}, \mathrm{~V}_{\mathrm{CE}}=5 \mathrm{~V}, \mathrm{Z}_{\mathrm{S}}=50 \Omega, \\ & f=800 \mathrm{MHz} \end{aligned}$ | $N F_{\text {min }}$ | - | 3 | 5 | dB |
| Transducer gain $\begin{aligned} & I_{\mathrm{C}}=20 \mathrm{~mA}, V_{\mathrm{CE}}=5 \mathrm{~V}, \mathrm{Z}_{\mathrm{S}}=\mathrm{Z}_{\mathrm{L}}=50 \Omega, \\ & f=500 \mathrm{MHz} \end{aligned}$ | $\left\|S_{21 \mathrm{e}}\right\|^{2}$ | - | 14 | - | dB |
| Third order intercept point at output $\begin{aligned} & V_{\mathrm{CE}}=5 \mathrm{~V}, I_{\mathrm{C}}=20 \mathrm{~mA}, f=800 \mathrm{MHz} \\ & Z_{\mathrm{S}}=Z_{\text {Sopt }}, Z_{\mathrm{L}}=Z_{\text {Lopt }} \end{aligned}$ | $I P_{3}$ | - | 22.5 | - | dBm |
| 1dB compression point $\begin{aligned} & I_{\mathrm{C}}=20 \mathrm{~mA}, V_{\mathrm{CE}}=5 \mathrm{~V}, \mathrm{Z}_{\mathrm{S}}=\mathrm{Z}_{\mathrm{L}}=50 \Omega, \\ & f=800 \mathrm{MHz} \end{aligned}$ | $P_{-1 \mathrm{~dB}}$ | - | 11 | - | - |

Total power dissipation $P_{\text {tot }}=f\left(T_{\mathrm{S}}\right)$


Permissible Pulse Load
$P_{\text {totmax }} / P_{\text {totDC }}=f\left(t_{\mathrm{p}}\right)$


Permissible Pulse Load $R_{\text {thJS }}=f\left(t_{\mathrm{p}}\right)$


Collector-base capacitance $C_{\mathrm{Cb}}=f\left(V_{\mathrm{CB}}\right)$
Emitter-base capacitance $C_{\text {eb }}=f\left(V_{\mathrm{EB}}\right)$
$f=1 \mathrm{MHz}$


Transition frequency $f_{\mathrm{T}}=f\left(I_{\mathrm{C}}\right)$
$V_{C E}=$ parameter


## Package Outline



Foot Print


## Marking Layout (Example)

Small variations in positioning of
Date code, Type code and Manufacture are possible.


## Standard Packing

Reel $\varnothing 180 \mathrm{~mm}=3.000$ Pieces/Reel
Reel $\varnothing 330 \mathrm{~mm}=10.000$ Pieces/Reel
For symmetric types no defined Pin 1 orientation in reel.


## Edition 2009-11-16

Published by<br>Infineon Technologies AG<br>81726 Munich, Germany

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[^0]:    ${ }^{1} T_{\mathrm{S}}$ is measured on the collector lead at the soldering point to the pcb
    ${ }^{2}$ For calculation of $R_{\text {thJA }}$ please refer to Application Note AN077 (Thermal Resistance Calculation)

